LCD / LCM SPECIFICATION



WINSTAR Display Co.,Ltd. 華凌光電股份有限公司



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SPECIFICATION

CUSTOMER : MODULE NO.:	WO12864U	J-TFH#
APPROVED BY: (FOR CUSTOMER USE ONLY)	PCB VERSION:	DATA:

SALES BY	APPROVED BY	CHECKED BY	PREPARED BY

VERSION	DATE	REVISED PAGE NO.	SUMMARY
C	2020/12/23		Add Interface



RECORDS OF REVISION			I	OOC. FIRST ISSUE	
VERSION	DATE	REVISED PAGE NO.	SHMMARY		
0	2019/04/29		Fir	st issue	
A	2019/08/27		Mo	odify Material List of	
			Co	mponents for RoHs	
В	2019/12/17		Modify Precautions in use		
			of I	LCD Modules	
C	2020/12/23		Ād	d Interface	

Contents

- 1. Module Classification Information
- 2.Precautions in use of LCD Modules
- 3.General Specification
- 4. Absolute Maximum Ratings
- 5. Electrical Characteristics
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- 9.Reliability
- 10.Backlight Information
- 11.Inspection specification
- 12. Material List of Components for RoHs
- 13.Recommendable Storage

1. Module Classification Information

① Brand: WINSTAR DISPLAY CORPORATION

② Display Type: H→Character Type, G→Graphic Type, X→TAB Type, O→COG Type

③ Display Font: 128 * 64 dot

Model serials no.

 $B\rightarrow EL$, Blue green $A\rightarrow LED$, Amber $J\rightarrow DIP$ LED, Blue $D\rightarrow EL$, Green $R\rightarrow LED$, Red $K\rightarrow DIP$ LED, White

W→EL, White O→LED, Orange E→DIP LED, Yellow Green

 $M\rightarrow EL$, Yellow Green $G\rightarrow LED$, Green $H\rightarrow DIP$ LED, Amber $F\rightarrow CCFL$, White $P\rightarrow LED$, Blue $I\rightarrow DIP$ LED, Red

 $Y\rightarrow$ LED, Yellow Green $X\rightarrow$ LED, Dual color $G\rightarrow$ LED, Green $C\rightarrow$ LED, Full color

© LCD Mode : B→TN Positive, Gray V→FSTN Negative, Blue

N→TN Negative, T→FSTN Negative, Black

L→VA Negative D→FSTN Negative (Double film)

 $H \rightarrow HTN$ Positive, Gray $F \rightarrow FSTN$ Positive $I \rightarrow HTN$ Negative, Black $K \rightarrow FSC$ Negative $U \rightarrow HTN$ Negative, Blue $S \rightarrow FSC$ Positive

M→STN Negative, Blue E→ISTN Negative, Black
G→STN Positive, Gray C→CSTN Negative, Black
Y→STN Positive, Yellow Green A→ASTN Negative, Black

② LCD Polarize A→Reflective, N.T, 6:00 H→Transflective, W.T,6:00

Type/ Temperature D→Reflective, N.T, 12:00 K→Transflective, W.T,12:00 range/ View G→Reflective, W. T, 6:00 C→Transmissive, N.T,6:00 direction J→Reflective, W. T, 12:00 F→Transmissive, N.T,12:00

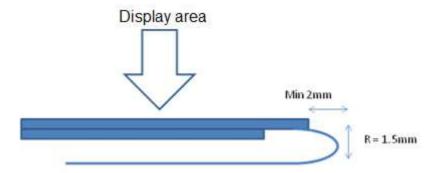
B→Transflective, N.T,6:00 I→Transmissive, W. T, 6:00

E→Transflective, N.T.12:00 L→Transmissive, W.T,12:00

Special Code #:Fit in with the ROHS Directions and regulations

2.Precautions in use of LCD Modules

- (1) Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Winstar have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Winstar have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Winstar have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11) The limitation of FPC bending



(12)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

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3.General Specification

Item	Dimension	Unit				
Number of dots	128 x 64	_				
Module dimension	58.2 x 44.7 x 3.9(MAX)	mm				
View area	52.0 x 33.5	mm				
Active area	47.76 x 30.29	mm				
Dot size	0.40 x 0.35	mm				
Dot pitch	0.42 x 0.37 mm					
LCD type	FSTN Positive Transflective					
	(In LCD production, It will occur slightly color of can only guarantee the same color in the same ba					
Duty	1/64					
View direction	6 o'clock					
Backlight Type	LED, White					
IC	ST7565P					
Interface	6800 series/8080 series/4-Line SPI					

4.Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	T_{OP}	-20	_	+70	$^{\circ}\!\mathbb{C}$
Storage Temperature	T_{ST}	-30	_	+80	$^{\circ}\!\mathbb{C}$
Power Supply Voltage	VDD	-0.3	_	3.6	V
Power supply voltage (VDD standard)	V0, VOUT	-0.3	_	14.5	V
Power supply voltage (VDD standard)	V1, V2, V3, V4	-0.3	_	V0+0.3	V

5.Electrical Characteristics

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage For Logic	V_{DD} - V_{SS}	_	3.0	_	3.3	V
		Ta=-20°C	_	_	_	V
Supply Voltage For LCD	V_{OP}	Ta=25°℃	8.3	8.5	8.7	V
		Ta=70°C	Γa=70°C −		_	V
Input High Volt.	V_{IH}	_	$0.8V_{\mathrm{DD}}$	_	$V_{ m DD}$	V
Input Low Volt.	V_{IL}	_	V_{SS}	_	$0.2V_{DD}$	V
Output High Volt.	V_{OH}	_	$0.8V_{\mathrm{DD}}$	_	V_{DD}	V
Output Low Volt.	V_{OL}	_	V_{DD}	_	$0.2V_{DD}$	V
Supply Current	I_{DD}	V _{DD} =3.3V	_	1	2	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

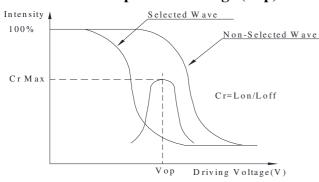
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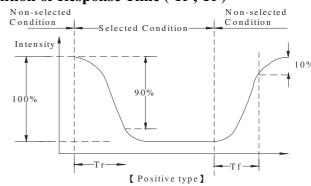
6.Optical Characteristics

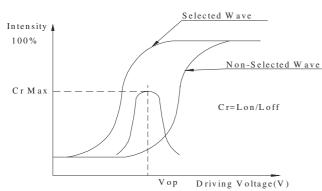
Item	Symbol	Condition	Min	Тур	Max	Unit
View Angle	θ	CR≧2	0	_	30	$\phi = 180^{\circ}$
	θ	CR≧2	0	_	60	$\phi = 0^{\circ}$
	θ	CR≧2	0	—	45	$\phi = 90^{\circ}$
	θ	CR≧2	0	_	45	$\phi = 270^{\circ}$
Contrast Ratio	CR	_	_	5	_	_
Response Time	T rise	_	_	200	300	ms
	T fall	_	_	250	350	ms

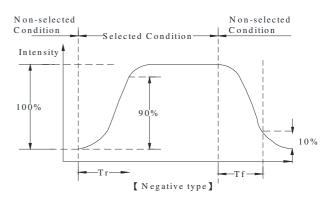
Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)









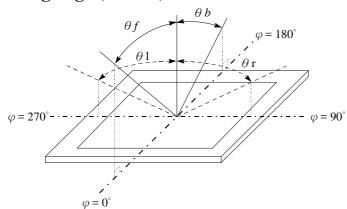
Conditions:

Operating Voltage: Vop

Viewing Angle(θ , φ): 0° , 0°

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

Definition of viewing angle $(CR \ge 2)$

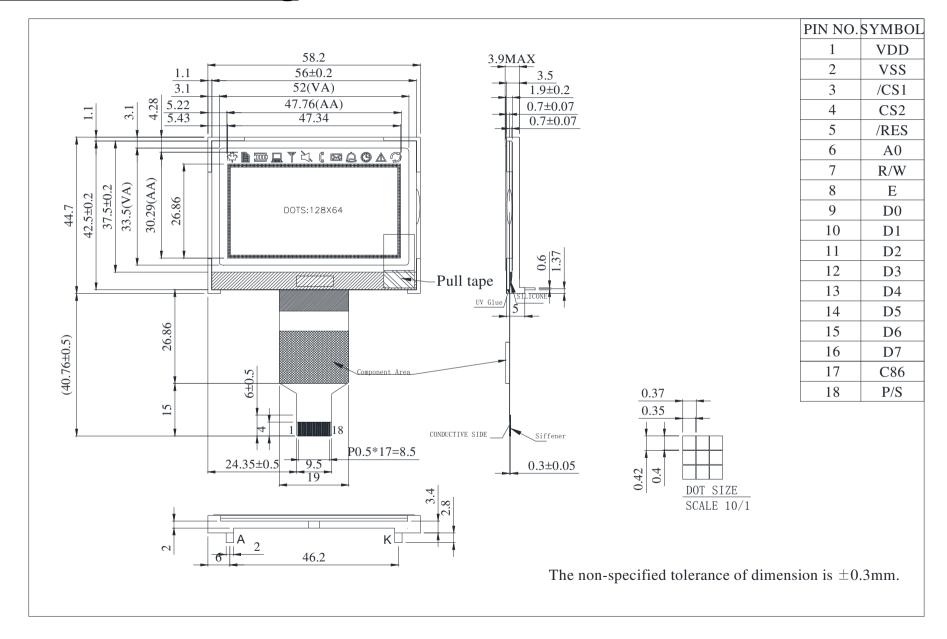


7.Interface Pin Function

Pin No.	Symbol	I/O	Description							
1	VDD	_	Power	Power supply pin for logic.						
2	VSS	_	Ground	l pin, connect	ted to 0V	I				
3	/CS1		Chip se	elect input pir	n. Interfa	ace access is enabled when CS1B is "L" and				
4	CS2	I		"H". When on the high impedate		on-active (CS1B="H" or CS2="L"), D[7:0]				
5	/RES	I		-	•	hen RSTB is "L", internal initialization is gisters will be initialized.				
6	A0	I	It deter	It determines whether the access is related to data or command. A0="H": Indicates that signals on D[7:0] are display data. A0="L": Indicates that signals on D[7:0] are command.						
			Read/V	Vrite execution	on contro	ol pin. When PSB is "H",				
	R/W		C86	MPU Type	RWR	Description				
7		R/W I	Н	6800 series	R/W	Read/Write control input pin. R/W="H": read. R/W="L": write.				
			L	8080 series	WR	Write enable input pin. Signals on D[7:0] will be latched at the rising edge of /WR signal.				
			RWR is	s not used in	serial in	terface and should fix to "H" by VDD.				
			Read/V	Vrite execution	on contro	ol pin. When PSB is "H",				
			C86	MPU Type	ERD	Description				
8	E	E	н	6800 series	E	Read/Write control input pin. R/W="H": When E is "H", D[7:0] are in output mode. R/W="L": Signals on D[7:0] are latched at the falling edge of E signal.				
			L	8080 series	/RD	Read enable input pin. When /RD is "L", D[7:0] are in output mode.				
			ERD is not used in serial interface and should fix to "H" by VDD.							
9-16	D0-D7	I/O	Data bu	is line						

			C86 selects the microprocessor type in parallel interface mode.					
			PSB	C86	Selected Interface			
			"H"	"H"	Parallel 6800 Series MPU Interface			
17	C86	I	"H"	"L"	Parallel 8080 Series MPU Interface			
			"L" "X" Serial 4-Line SPI Interface					
			Please refer to "APPLICATION NOTES" and "Microprocessor Interface" (Section 6) for detailed connection of the selected interface.					
18	P/S	I	PSB selects the interface type: Serial or Parallel.					

8.Contour Drawing



9.Reliability

Content of Reliability Test (Wide temperature, -20°C~70°C)

	Environmental Test							
Test Item	Content of Test	Test Condition	Not e					
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80°C 200hrs	2					
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2					
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs						
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1					
High Temperature/ Humidity storage	The module should be allowed to stand at 40 °C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	40°C,90%RH 96hrs	1,2					
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles						
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude: 1.5mm Vibration Frequency: 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3					
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times						

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

10.Backlight Information

Specification

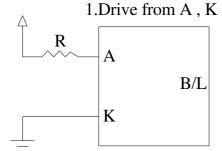
PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	36	48	60	mA	V= 3.5V
Supply Voltage	V	_	3.5	_	V	_
Reverse Voltage	VR	_	_	5	V	_
	X	0.25	0.28	0.31		H ED 40 A
Color coordinate	Y	0.27	0.30	0.33		ILED=48mA
Luminance	IV	688	860		CD/M ²	ILED=48mA
(Without LCD)	1,4	000	000		CD/M	1112D-40111A
LED Life Time	_	30K	_	_	Hr.	ILED=48mA 25°C,50-60% RH, (Note 2)
Color	White					

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1: Supply current minimum value is only for reference since LED brightness efficiency keeps enhancing. Current consumption becomes less and less to achieve the same luminance.

Note2:30K hours is only an estimate for reference.

LED B\L Drive Method



11.Inspection specification

NO	Item	Criterion				AQL
01	Electrical Testing	Missing vertical, horizontal segment, segment contrast defect. Missing character, dot or icon. Display malfunction. No function or no display. Current consumption exceeds product specifications. LCD viewing angle defect. Mixed product types. Contrast defect.				0.65
02	Black or white spots on LCD (display only)	three white or black spots I		on display ≤ 0.25 mm, no more than present.		2.5
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi=(x+y)/2$ X 3.2 Line type:	↓ Y	SIZE $\Phi \le 0.10$ $0.10 < \Phi \le 0.20$ $0.20 < \Phi \le 0.25$ $0.25 < \Phi$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY Acceptable Q TY Accept no dense 2 As round type	2.5
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.		Size Φ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5

NO	Item	Criterion					
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination					
	Chipped		Glass thickness a: LC	nip thickness CD side length			
		6.1 General glass chip: 6.1.1 Chip on panel surface and crack between panels:					
		z: Chip thickness	y: Chip width	x: Chip length			
06		Z≦1/2t	Not over viewing area	x ≤ 1/8a	2.5		
00	glass	$1/2t < z \le 2t$	Not exceed 1/3k	x ≤ 1/8a	2.3		
		6.1.2 Corner crack:	y: Chip width Not over viewing area Not exceed 1/3k e chips, x is the total len	x : Chip length $x \le 1/8a$ $x \le 1/8a$			

NO	Item	Criterion			AQL			
		Symbols:						
		x: Chip length y: Cl	hip width z: Chi	p width z: Chip thickness				
		k: Seal width t: Gl	ass thickness a: LCI	D side length				
		L: Electrode pad length						
		6.2 Protrusion over terminal :						
		6.2.1 Chip on electrode pa	d:					
06	Glass		: Chip length ≤ 1/8a ion:	$\begin{array}{c} z\text{: Chip thickness} \\ 0 \ < \ z \le t \end{array}$	2.5			
		y: Chip width	x: Chip length	z: Chip thickness				
		$y \le L$	x ≤ 1/8a	$0 < z \le t$				
			hes the ITO terminal,	over 2/3 of the ITO must				
		remain and be inspected as						
		=	=	mer, the alignment mark not				
		be damaged.						
		6.2.3 Substrate protuberan	ce and internal crack.					
		X	y: width	x: length				
			$x \leq a$					
		(A)						

NO	Item	Criterion	AQL		
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5		
08	Backlight elements	 8.1 Illumination source flickers when lit. 8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards. 8.3 Backlight doesn't light or color wrong. 	0.65 2.5 0.65		
09	9.1 Bezel may not have rust, be deformed or have fingerprint stains or other contamination. 9.2 Bezel must comply with job specifications.				
10	PCB · COB				
11	Soldering	11.1 No un-melted solder paste may be present on the PCB. 11.2 No cold solder joints, missing solder connections, oxidation or icicle. 11.3 No residue or solder balls on PCB. 11.4 No short circuits in components on PCB.	2.5 2.5 2.5 0.65		

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface	2.5
		Pin (OLB) of TCP.	
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to sever.	
	Company	12.6 The residual rosin or tin oil of soldering (component or chip	2.5
12	General appearance component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins.	component) is not burned into brown or black color.	
		12.7 Sealant on top of the ITO circuit has not hardened.	2.5
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Product packaging must the same as specified on packaging	0.65
		specification sheet.	
		12.11 Product dimension and structure must conform to product	0.65
		specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	0.65

12.Material List of Components for

RoHs

1. WINSTAR Display Co., Ltd hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value	Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp									
Above limited value is set up according to RoHS.										

2.Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp.:

Reflow: 250° C, 30 seconds Max.;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. $: 235\pm5^{\circ}\mathbb{C}$;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

13. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

		e Feedback Sheet
Module Number :		Page: 1
1 \ Panel Specification :		
1. Panel Type:	☐ Pass	□ NG ,
2. View Direction:	Pass	□ NG ,
3. Numbers of Dots:	Pass	□ NG ,
4. View Area:	Pass	□ NG ,
5. Active Area:	☐ Pass	□ NG ,
6. Operating Temperature:	☐ Pass	□ NG ,
7. Storage Temperature:	☐ Pass	☐ NG ,
8. Others:		
2 · Mechanical Specification:		
1. PCB Size:	☐ Pass	□ NG ,
2. Frame Size:	Pass	□ NG ,
3. Materal of Frame:	Pass	□ NG ,
4. Connector Position:	Pass	□ NG ,
5. Fix Hole Position:	Pass	□ NG ,
6. Backlight Position:	Pass	□ NG ,
7. Thickness of PCB:	Pass	□ NG ,
8. Height of Frame to PCB:	Pass	□ NG ,
9. Height of Module:	Pass	□ NG ,
10. Others:	Pass	□ NG ,
3 · <u>Relative Hole Size</u> :		
1. Pitch of Connector:	Pass	□ NG ,
2. Hole size of Connector:	Pass	□ NG ,
3. Mounting Hole size:	Pass	□ NG ,
4. Mounting Hole Type:	Pass	□ NG ,
5. Others:	Pass	□ NG ,
4 · Backlight Specification :		
1. B/L Type:	Pass	□ NG ,
2. B/L Color:	Pass	□ NG ,
3. B/L Driving Voltage (Refere	ence for LED	Type): Pass NG,
4. B/L Driving Current:	☐ Pass	□ NG ,
5. Brightness of B/L:	Pass	□ NG ,
6. B/L Solder Method:	☐ Pass	□ NG ,
7. Others:	Pass	□ NG ,
7. Others:	_	□ NG,



	winstar		Page: 2			
Modu	le Number:	,				
5、	Electronic Characteristics of	Module:				
1.	Input Voltage:	Pass	□ NG ,			
2.	Supply Current:	Pass	□ NG ,			
3.	Driving Voltage for LCD:	Pass	□ NG ,			
4.	Contrast for LCD:	Pass	□ NG ,			
5.	B/L Driving Method:	Pass	□ NG ,			
6.	Negative Voltage Output:	Pass	□ NG ,			
7.	Interface Function:	Pass	□ NG ,			
8.	LCD Uniformity:	Pass	□ NG ,			
9.	ESD test:	Pass	□ NG ,			
10.	Others:	☐ Pass	□ NG ,			
6、	Summary:					
	Sales signature:		Detect /			
	Customer Signature:		Date: / /			